502757745 04/08/2014

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 EPAS ID: PAT2804341 Stylesheet Version v1.2

SUBMISSION TYPE: NEW ASSIGNMENT

NATURE OF CONVEYANCE: ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Shunpei Yamazaki	10/19/2010
Jun Koyama	10/23/2010
Kiyoshi Kato	10/25/2010

RECEIVING PARTY DATA

Name:	SEMICONDUCTOR ENERGY LABORATORY CO., LTD.	
Street Address:	398, HASE	
City:	ATSUGI-SHI, KANAGAWA-KEN	
State/Country:	JAPAN	
Postal Code:	243-0036	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14186005

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ATTORNEY DOCKET NUMBER: 12732-0731003

NAME OF SUBMITTER: APRIL K. SAUNDERS-FULLER

SIGNATURE: /April K. Saunders-Fuller/

DATE SIGNED: 04/08/2014

Total Attachments: 1

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PATENT 502757745 REEL: 032624 FRAME: 0086

ASSIGNMENT

For valuable consideration, We, <u>Shunpei YAMAZAKI of Setagaya</u>, <u>Tokyo</u>, <u>Japan</u>, <u>Jun KOYAMA of Sagamihara</u>, <u>Kanagawa</u>, <u>Japan and Kiyoshi KATO of Atsugi</u>, <u>Kanagawa</u>, <u>Japan</u> hereby assign to <u>Semiconductor Energy Laboratory Co.</u>, <u>Ltd.</u>, a <u>Japanese</u> corporation having a place of business at:

398, Hase, Atsugi-shi, Kanagawa-ken, 243-0036 Japan

and its successors and assigns (collectively hereinafter called "the Assignee"), the entire right, title and interest throughout the world in the inventions and improvements which are subject of an application for States Patent signed by us this day, entitled SEMICONDUCTOR DEVICE, United filed 02/21/2014 , and assigned U.S. Serial Number 14/186,005 authorize and request the attorneys appointed in said application to hereafter complete this assignment by inserting above the filing date and serial number of said application when known; this assignment including said application, any and all United States and foreign patents, utility models, and design registrations granted for any of said inventions or improvements, and the right to claim priority based on the filing date of said application under the International Convention for the Protection of Industrial Property, the Patent Cooperation Treaty, the European Patent Convention, and all other treaties of like purposes; and we authorize the Assignee to apply in all countries in our name or in its own name for patents, utility models, design registrations and like rights of exclusion and for inventors' certificates for said inventions and improvements; and we agree for ourselves and our respective heirs, legal representatives and assigns, without further compensation to perform such lawful acts and to sign such further applications, assignments, Preliminary Statements and other lawful documents as the Assignee may reasonably request to effectuate fully this assignment.

Signature
Name: Shunpei YAMAZAKA

Date: /0/19/20/0

Signature
Name: Jun KOYAMA

Date: /0/23/20(0

Signature
Name: Kiyoshi KATO

Date: /0/25/20/0

RECORDED: 04/08/2014

PATENT REEL: 032624 FRAME: 0087